



## SEMIPACK<sup>®</sup> 1

### Rectifier Diode Modules

#### SKKD 26

#### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

#### Typical Applications

- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors
- SKKE: Free-wheeling diodes

$V_{RSM}$ V	$V_{RRM}$ V	$I_{FRMS} = 60$ A (maximum value for continuous operation) $I_{FAV} = 26$ A (sin. 180; $T_c = 93$ °C)	
1300	1200	SKKD 26/12	
1500	1400	SKKD 26/14	
1700	1600	SKKD 26/16	

Symbol	Conditions	Values	Units
$I_{FAV}$	sin. 180; $T_c = 85$ (100) °C	31 (21)	A
$I_D$	P3/120; $T_a = 45$ °C; B2 / B6	44 / 48	A
	P3/180; $T_a = 45$ °C; B2 / B6	53 / 59	A
$I_{FSM}$	$T_{vj} = 25$ °C; 10 ms	550	A
	$T_{vj} = 125$ °C; 10 ms	480	A
$i^2t$	$T_{vj} = 25$ °C; 8,3 ... 10 ms	1500	A <sup>2</sup> s
	$T_{vj} = 125$ °C; 8,3 ... 10 ms	1150	A <sup>2</sup> s
$V_F$	$T_{vj} = 25$ °C; $I_F = 75$ A	max. 1,35	V
$V_{(TO)}$	$T_{vj} = 125$ °C	max. 0,85	V
$r_T$	$T_{vj} = 125$ °C	max. 6	mΩ
$I_{RD}$	$T_{vj} = 125$ °C; $V_{RD} = V_{RRM}$	max. 3	mA
$R_{th(j-c)}$	per diode / per module	1 / 0,5	K/W
$R_{th(c-s)}$	per diode / per module	0,2 / 0,1	K/W
$T_{vj}$		- 40 ... + 125	°C
$T_{stg}$		- 40 ... + 125	°C
$V_{isol}$	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 / 3000	V~
$M_s$	to heatsink	5 ± 15 %	Nm
$M_t$	to terminals	3 ± 15 %	Nm
$a$		5 * 9,81	m/s <sup>2</sup>
$m$	approx.	95	g
Case		A 10	



SKKD

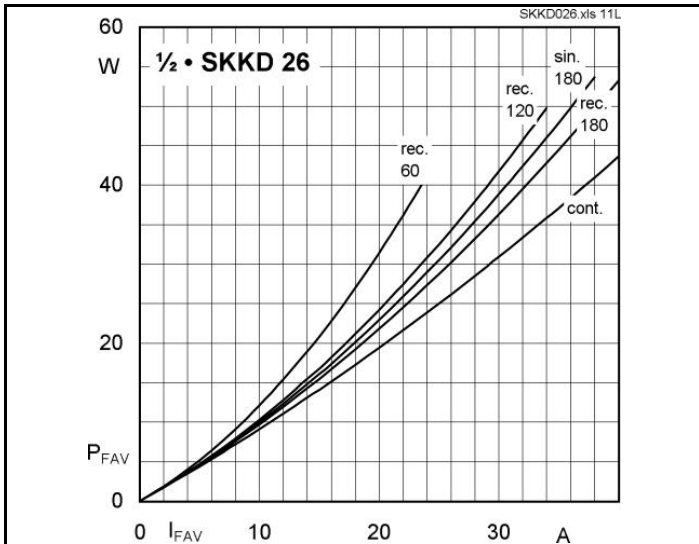


Fig. 11L Power dissipation per diode vs. forward current

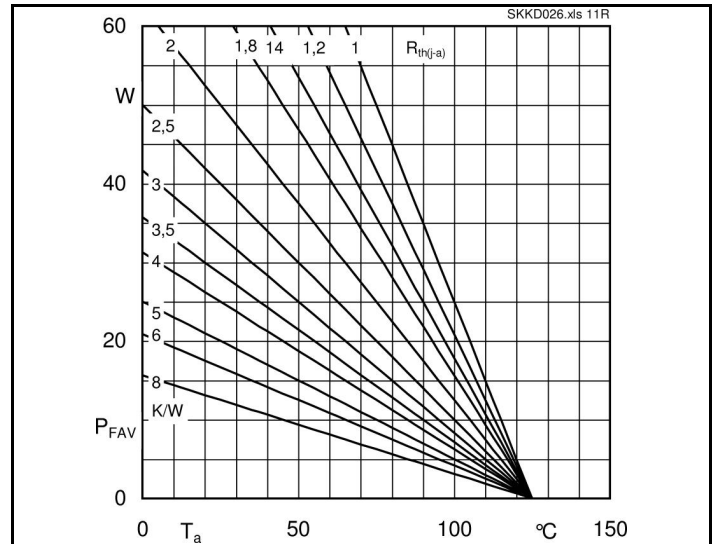


Fig. 11R Power dissipation per diode vs. ambient temperature

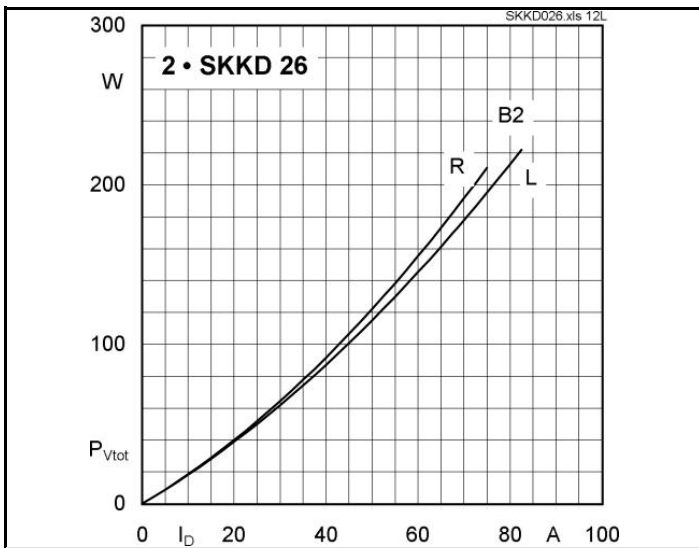


Fig. 12L Power dissipation of two modules vs. direct current

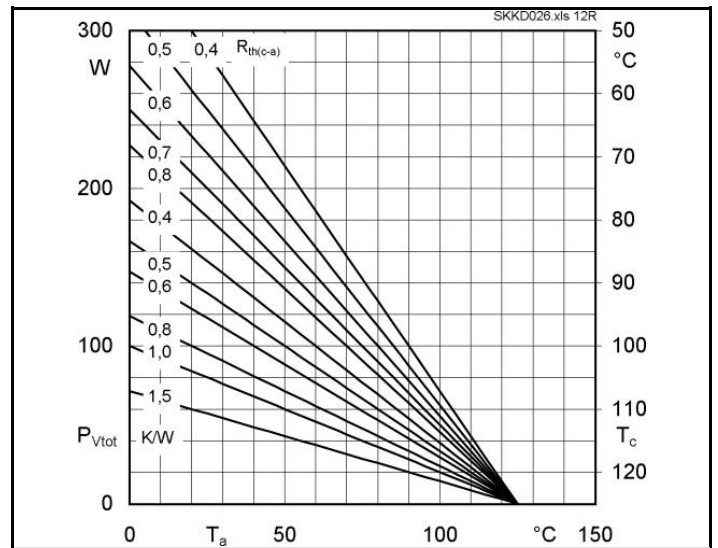


Fig. 12R Power dissipation of two modules vs. case temperature

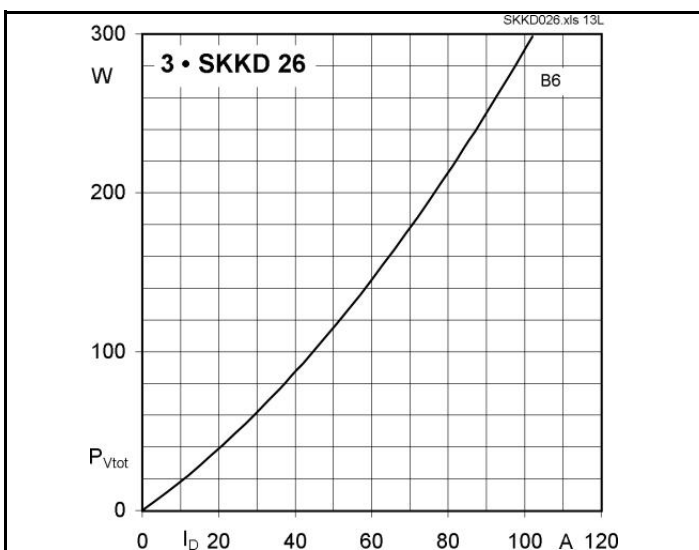


Fig. 13L Power dissipation of three modules vs. direct current

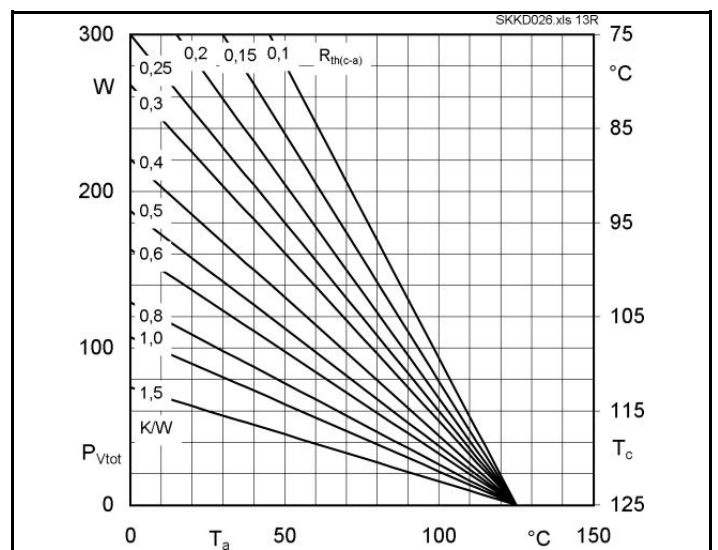
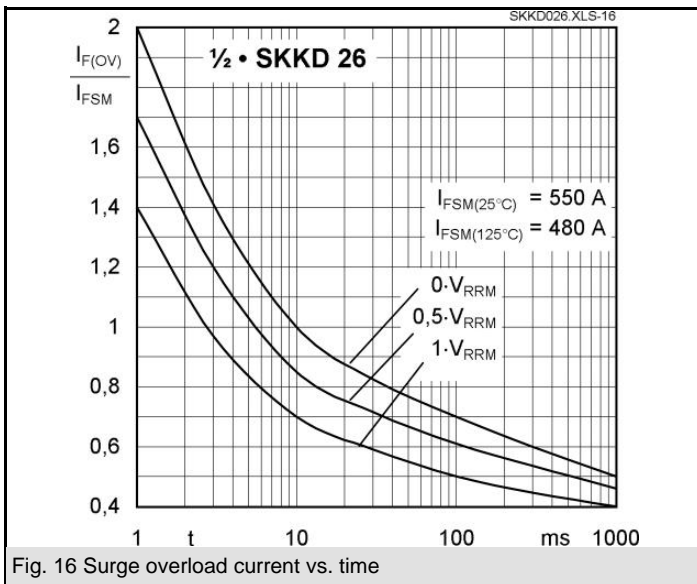
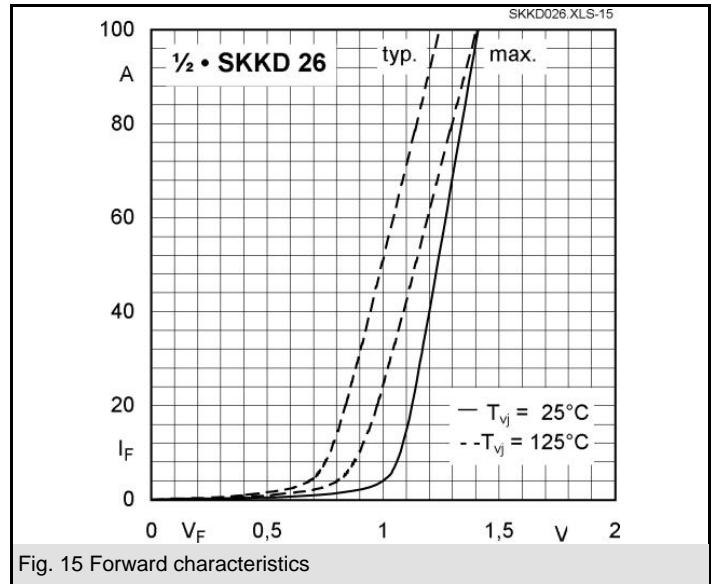
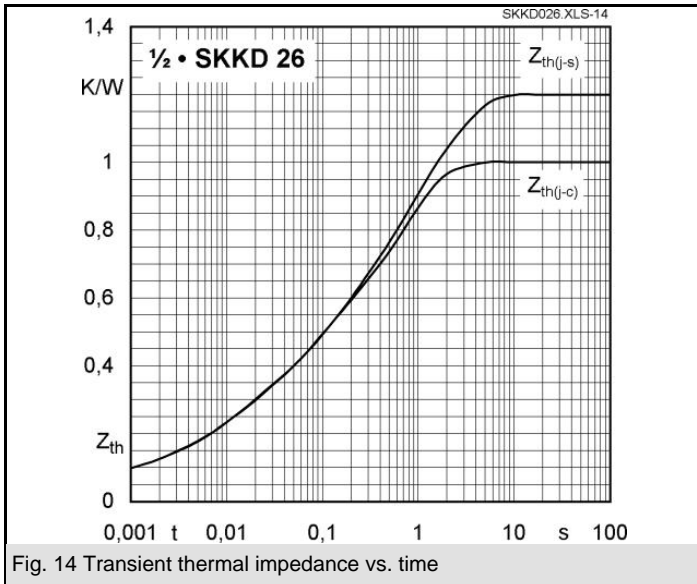
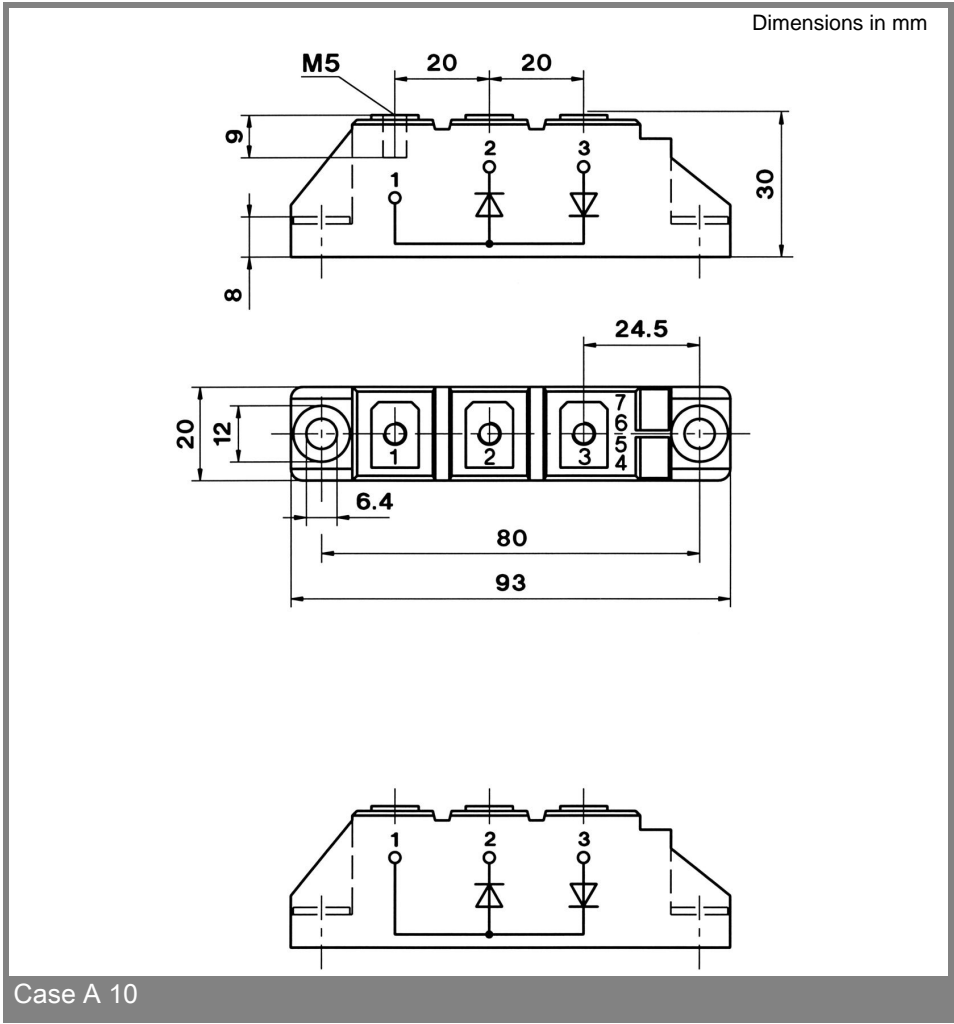


Fig. 13R Power dissipation of three modules vs. case temperature





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